

## 74F620 • 74F623

### Inverting Octal Bus Transceiver with 3-STATE Outputs

#### General Description

These devices are octal bus transceivers designed for asynchronous two-way data flow between the A and B busses. Both busses are capable of sinking 64 mA and have 3-STATE outputs. Dual enable pins ( $G_{AB}$ ,  $\bar{G}_{BA}$ ) allow data transmission from the A bus to the B bus or from the B bus to the A bus. The 74F620 is an inverting option of the 74F623.

#### Features

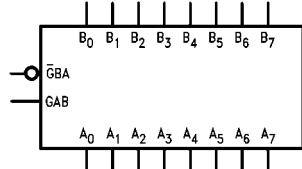
- Designed for asynchronous two-way data flow between busses
- Outputs sink 64 mA
- Dual enable inputs control direction of data flow
- Guaranteed 4000V minimum ESD protection
- 74F620 is an inverting option of the 74F623

#### Ordering Code:

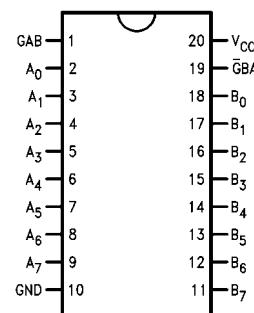
Order Number	Package Number	Package Description
74F620PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
74F623SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74F623PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

#### Logic Symbol



#### Connection Diagram



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## Unit Loading/Fan Out

Pin Names	Description	U.L. HIGH/LOW	Input $I_{IH}/I_{IL}$ Output $I_{OH}/I_{OL}$
$\bar{G}_{BA}, G_{AB}$ $A_0-A_7$	Enable Inputs A Inputs or 3-STATE Outputs	1.0/1.0 3.5/1.083	20 $\mu A$ –0.6 mA 70 $\mu A$ –0.4 mA
	B Inputs or 3-STATE Outputs	150/40 3.5/1.083	-3 mA/64 mA 70 $\mu A$ –0.4 mA
$B_0-B_7$		150/40	-3 mA/64 mA

## Functional Description

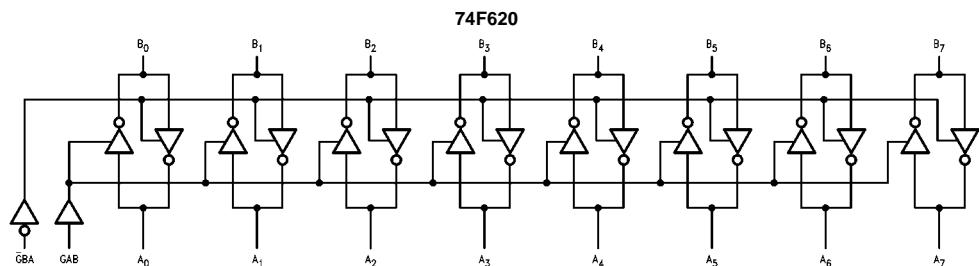
The enable inputs  $G_{AB}$  and  $\bar{G}_{BA}$  control whether data is transmitted from the A bus to the B bus or from the B bus to the A bus. If both  $\bar{G}_{BA}$  and  $G_{AB}$  are disabled ( $\bar{G}_{BA}$  HIGH and  $G_{AB}$  LOW), the outputs are in the high impedance state and data is stored at the A and B busses. When  $\bar{G}_{BA}$  is active LOW, B data is sent to the A bus. When  $G_{AB}$  is active HIGH, data from the A bus is sent to the B bus. If both enable inputs are active ( $\bar{G}_{BA}$  LOW and  $G_{AB}$  HIGH) B data is sent to the A bus while A data is sent to the B bus.

## Function Table

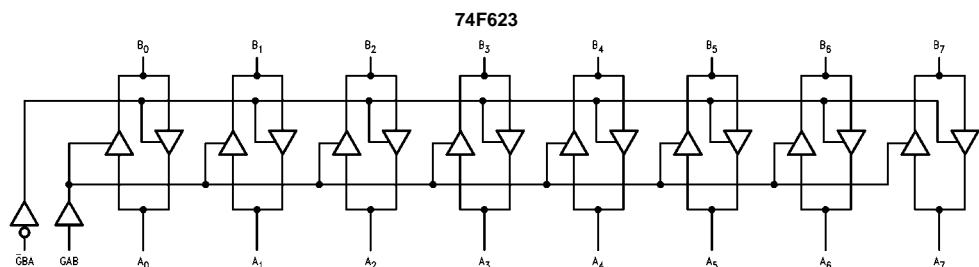
Enable Inputs		Operation	
$\bar{G}_{BA}$	$G_{AB}$	74F620	74F623
L	L	$\bar{B}$ Data to A Bus	B Data to A Bus
H	H	$\bar{A}$ Data to B Bus	A Data to B Bus
H	L	Z	Z
L	H	$\bar{B}$ Data to A Bus, $\bar{A}$ Data to B Bus	B Data to A Bus, A Data to B Bus

H = HIGH Voltage Level  
L = LOW Voltage Level  
Z = High Impedance

## Logic Diagrams



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.



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**Absolute Maximum Ratings**(Note 1)

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	-55°C to +150°C
V <sub>CC</sub> Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to +7.0V
Input Current (Note 2)	-30 mA to +5.0 mA
Voltage Applied to Output	
in HIGH State (with V <sub>CC</sub> = 0V)	
Standard Output	-0.5V to V <sub>CC</sub>
3-STATE Output	-0.5V to +5.5V
Current Applied to Output	
in LOW State (Max)	twice the rated I <sub>OL</sub> (mA)
ESD Last Passing Voltage (Min)	4000V

**Recommended Operating Conditions**

Free Air Ambient Temperature 0°C to +70°C

Supply Voltage +4.5V to +5.5V

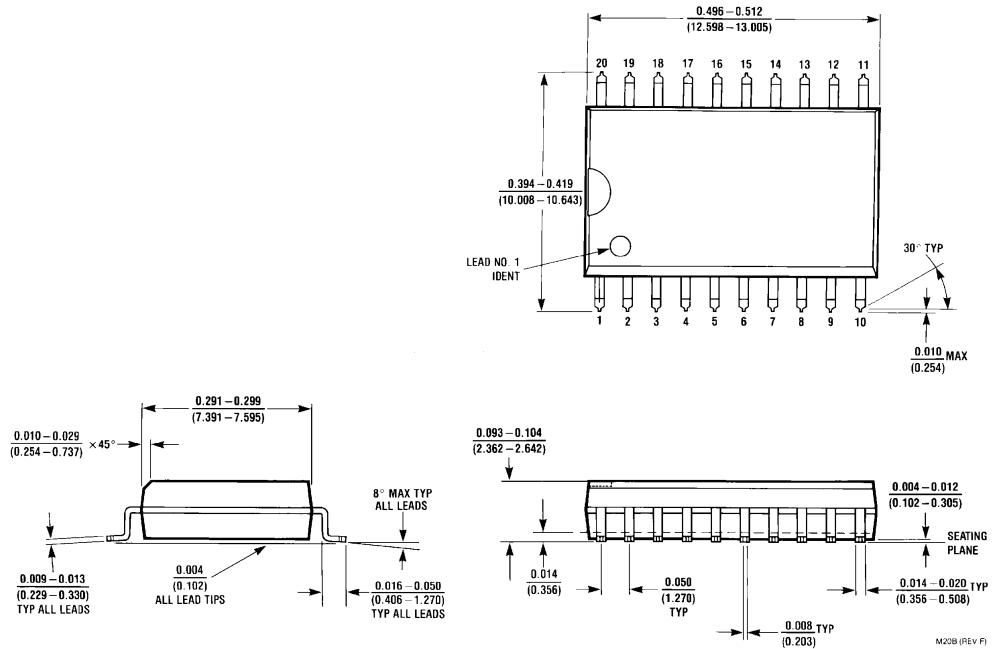
**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.**Note 2:** Either voltage limit or current limit is sufficient to protect inputs.**DC Electrical Characteristics**

Symbol	Parameter	Min	Typ	Max	Units	V <sub>CC</sub>	Conditions
V <sub>IH</sub>	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V <sub>IL</sub>	Input LOW Voltage		0.8		V		Recognized as a LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltage		-1.2		V	Min	I <sub>IN</sub> = -18 mA (Non I/O Pins)
V <sub>OH</sub>	Output HIGH Voltage	10% V <sub>CC</sub>	2.0		V	Min	I <sub>OH</sub> = -15 mA (A <sub>n</sub> , B <sub>n</sub> )
V <sub>OL</sub>	Output LOW Voltage	10% V <sub>CC</sub>		0.55	V	Min	I <sub>OL</sub> = 64 mA (A <sub>n</sub> , B <sub>n</sub> )
I <sub>IH</sub>	Input HIGH Current			5.0	µA	Max	V <sub>IN</sub> = 2.7V
I <sub>BVI</sub>	Input HIGH Current Breakdown Test			7.0	µA	Max	V <sub>IN</sub> = 7.0V (GBA, GAB)
I <sub>BVIT</sub>	Input HIGH Current Breakdown (I/O)			0.5	mA	Max	V <sub>IN</sub> = 5.5V (A <sub>n</sub> , B <sub>n</sub> )
I <sub>CEx</sub>	Output HIGH Leakage Current			50	µA	Max	V <sub>OUT</sub> = V <sub>CC</sub>
V <sub>ID</sub>	Input Leakage Test	4.75			V	0.0	I <sub>ID</sub> = 1.9 µA All Other Pins Grounded
I <sub>OD</sub>	Output Leakage Circuit Current			3.75	µA	0.0	V <sub>IOD</sub> = 150 mV All Other Pins Grounded
I <sub>IL</sub>	Input LOW Current			-0.6	mA	Max	V <sub>IN</sub> = 0.5V (Non I/O Pins)
I <sub>IH</sub> + I <sub>OZH</sub>	Output Leakage Current			70	µA	Max	V <sub>OUT</sub> = 2.7V (A <sub>n</sub> , B <sub>n</sub> )
I <sub>IL</sub> + I <sub>OZL</sub>	Output Leakage Current			-650	µA	Max	V <sub>OUT</sub> = 0.5V (A <sub>n</sub> , B <sub>n</sub> )
I <sub>OS</sub>	Output Short-Circuit Current	-100	-225		mA	Max	V <sub>OUT</sub> = 0V
I <sub>ZZ</sub>	Bus Drainage Test			500	µA	0.0V	V <sub>OUT</sub> = 5.25V
I <sub>CCH</sub>	Power Supply Current (74F620)		82		mA	Max	V <sub>O</sub> = HIGH, V <sub>IN</sub> = 0.2V
I <sub>CCL</sub>	Power Supply Current (74F620)		82		mA	Max	V <sub>O</sub> = LOW
I <sub>CCZ</sub>	Power Supply Current (74F620)		95		mA	Max	V <sub>O</sub> = HIGH Z
I <sub>CCH</sub>	Power Supply Current (74F623)		65		mA	Max	V <sub>O</sub> = HIGH
I <sub>CCL</sub>	Power Supply Current (74F623)		82		mA	Max	V <sub>O</sub> = LOW, V <sub>IN</sub> = 0.2V
I <sub>CCZ</sub>	Power Supply Current (74F623)		85		mA	Max	V <sub>O</sub> = HIGH Z

### AC Electrical Characteristics

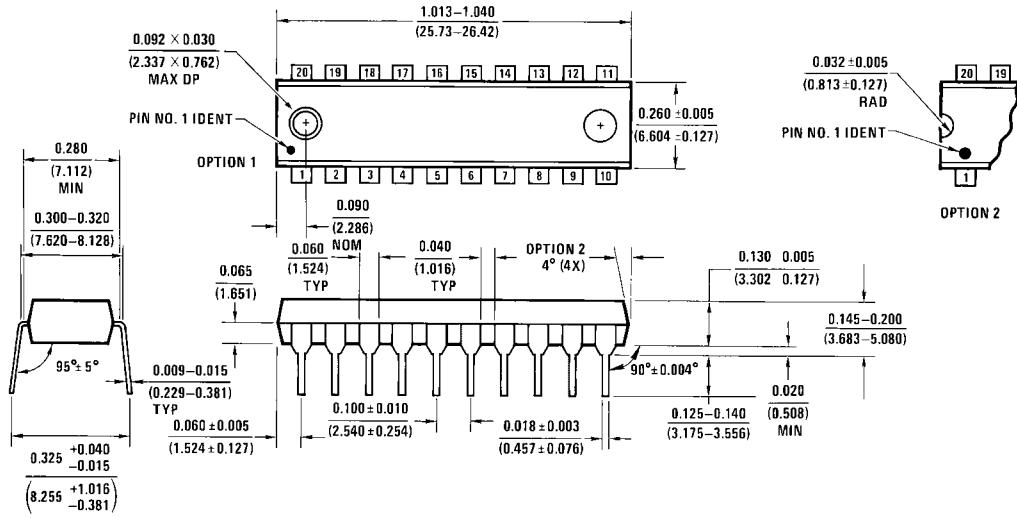
Symbol	Parameter	$T_A = +25^\circ C$ $V_{CC} = +5.0V$ $C_L = 50 pF$			$T_A = 0^\circ C \text{ to } +70^\circ C$ $V_{CC} = +5.0V$ $C_L = 50 pF$		Units
		Min	Typ	Max	Min	Max	
$t_{PLH}$	Propagation Delay A Input to B Output (74F620)	2.5	7.5	2.0	8.0		ns
		2.0	7.0	2.0	7.0		
$t_{PLH}$	Propagation Delay B Input to A Output (74F620)	2.5	7.5	2.0	8.0		ns
		2.0	7.0	2.0	7.0		
$t_{PLH}$	Propagation Delay A Input to B Output (74F623)	1.5	6.5	1.5	7.5		ns
		2.0	7.0	2.0	7.5		
$t_{PLH}$	Propagation Delay B Input to A Output (74F623)	1.5	6.5	1.5	7.5		ns
		2.0	7.0	2.0	7.5		
$t_{PZH}$	Enable Time GBA Input to A Output	2.0	7.0	2.0	8.0		ns
		2.5	8.0	2.0	8.5		
$t_{PHZ}$	Disable Time GBA Input to A Output	1.5	6.5	1.5	7.5		ns
		1.0	5.5	1.0	5.5		
$t_{PZH}$	Enable Time GAB Input to B Output (74F620)	2.0	7.5	2.0	8.5		ns
		3.0	8.0	2.0	8.5		
$t_{PHZ}$	Disable Time GAB Input to B Output (74F620)	2.5	8.0	2.0	9.0		ns
		2.0	7.5	2.0	8.0		
$t_{PZH}$	Enable Time GAB Input to B Output (74F623)	2.0	7.5	2.0	8.5		ns
		2.5	8.0	2.0	8.5		
$t_{PHZ}$	Disable Time GAB Input to B Output (74F623)	2.0	8.0	2.0	9.0		ns
		2.0	8.0	2.0	8.0		

**Physical Dimensions** inches (millimeters) unless otherwise noted



20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide  
Package Number M20B

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



N20A (REV G)

20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide  
Package Number N20A

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